Welcome to O-leading

O-Leading strives to be your one stop solution partner in EMS supply chain, including PCB design , PCB fabrication and PCB assembly (**China PCB Assembly PCBA Manufacturer**), We provide some of the most advanced PCB technology, including HDI PCBs, multilayer PCBs, Rigid-Flexible PCBs. We can support from quick turn prototype to medium & mass Production.

In general, our global customers are very impressed with our services:Rapid response, competitive price and quality commitment.Providing more valuable technical service and overall solution is the way O-leading forward.

Looking to the future, O-leading will concentrate on the innovation and development of electronics manufacturing technology as always, and make persistent efforts on PCB & PCBA one-stop service to provide first-class services and create more value for our customers.

PLEASE CLICK THESE FOR MORE INFORMATION

OEM PCBA Assembling Protective PCB

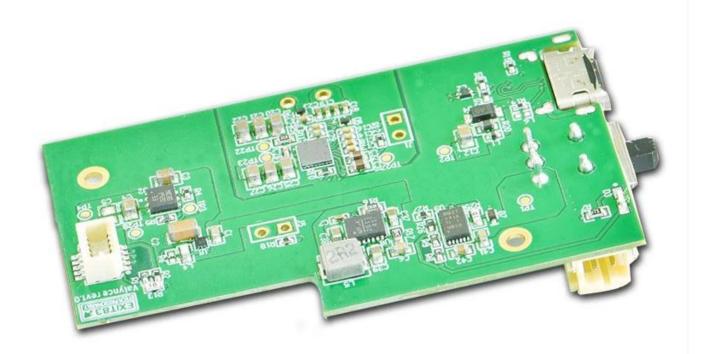
Coating Board



Product Description

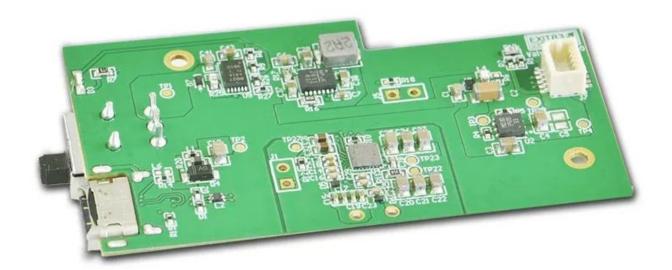






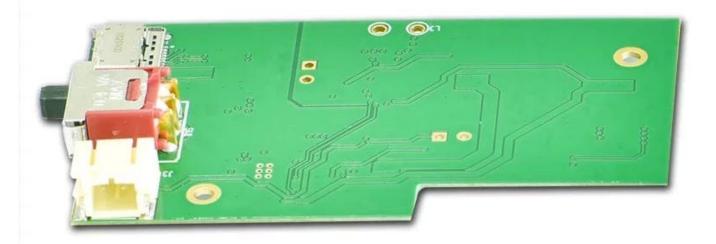






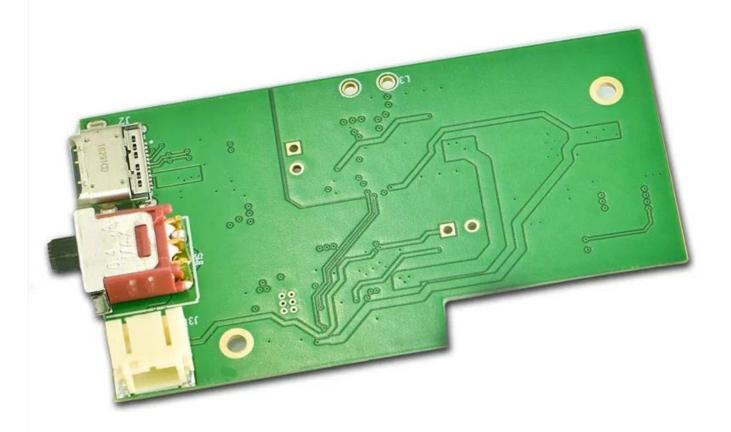








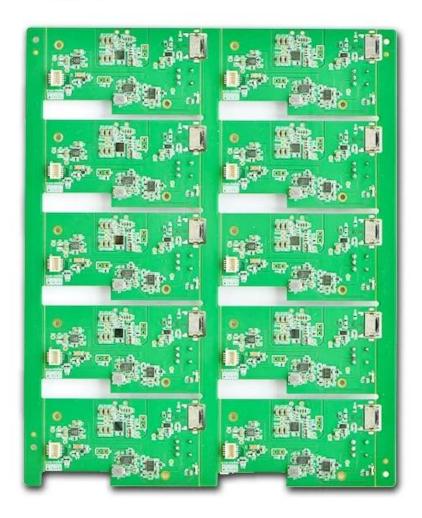




TOP QUALITY PCBA



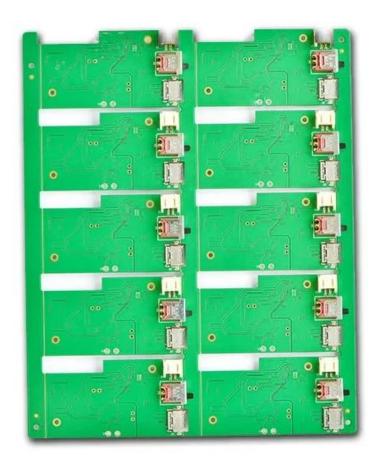




TOP QUALITY PCBA



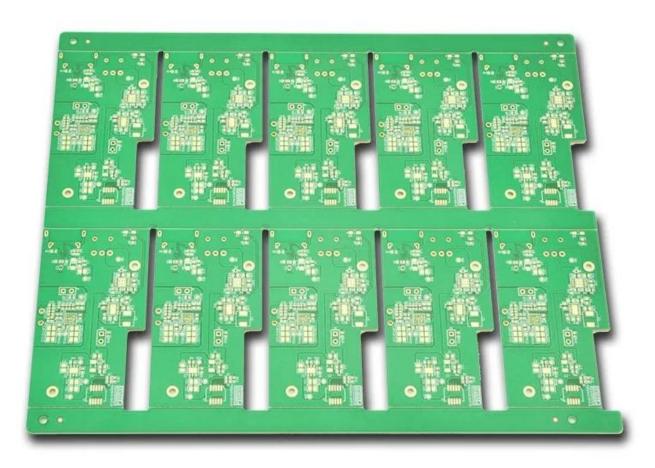




TOP QUALITY PCBA

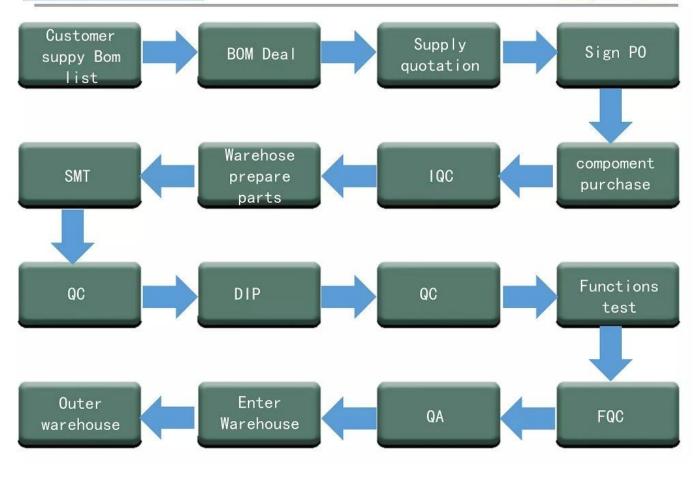






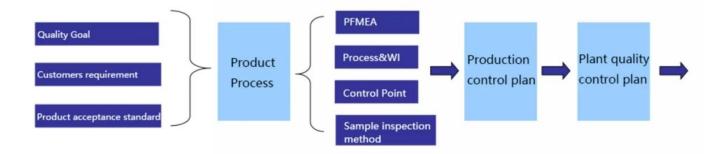
Process Flow Chart

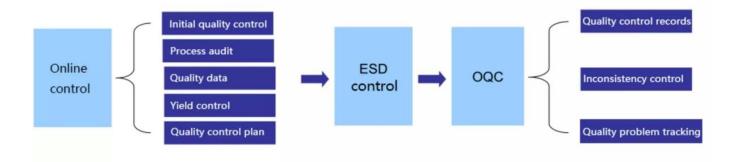




Quality Control Process

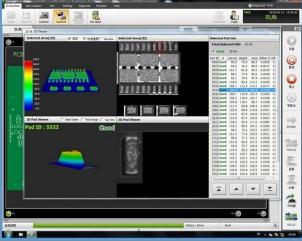


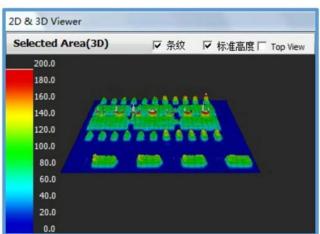


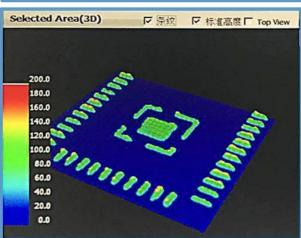


KOHYOUNG solder pasteig check SPI Figure 3 d imaging









Our Team

To be #ELIABLE

Quality first ,

Customer supreme,

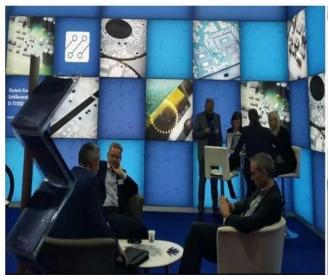
Scientifically management,

Striving for famous brand





THE CUSTOMER IS KING





To be VALUABLE

Science and technology keeps head ,

Put people first,

Be precise and practical,

contribute sincerely

Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

Factory SMT





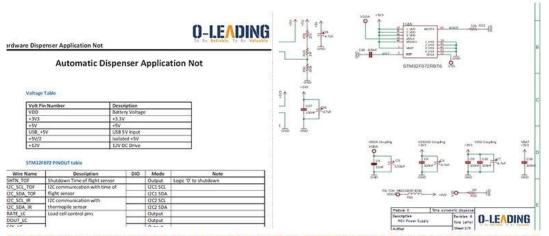








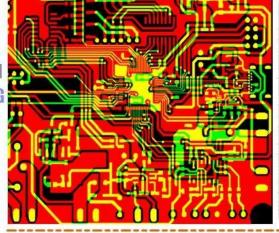
HOW O-LEADING MAKE A PROJECT FOR YOU



HARDWARE schematics

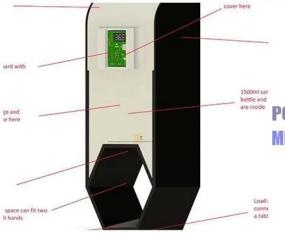
PCB PRODUCTION COMPONNETS SOURCING





| Qty | Value | Device | Parts | Description |
|-----|---------|---------------|---------|---|
| 4 | AK500/2 | AK500/2 | X1, X2, | CONNECTOR |
| 1 | AK500/3 | AK500/3 | X7 | CONNECTOR |
| 1 | 1241148 | MA04-2 | SV2 | 8,000 F. 100,11 S. 100 S. |
| 1 | PPPC04 | MA04-2 | SV1 | 8 POS , 4*2 FEMALE PIN HEADE |
| 1 | ML10 | ML10 | SV4 | HARTING |
| 1 | 8MHZ | XTALL_CSTCE8M | X5 | STCE8M00G52-R0 RESONATOR |
| 1 | OR | R-0603 | R53 | Thick Film Resistors - SMD 0603 |
| 2 | 10R | R-0603 | R12, R5 | Thick Film Resistors - SMD 0603 |
| 8 | 100R | R-0603 | R1, R2, | Thick Film Resistors - SMD 0603 |
| 1 | 270R | R-0805 | R15 | Thick Film Resistors - SMD 0605 |
| 1 | 330R | R-0603 | R11 | Thick Film Resistors - SMD 0603 |
| 9 | 680R | R-0603 | R20, R3 | Thick Film Resistors - SMD 0603 |
| 17 | 1k | R-0603 | R9, R10 | Thick Film Resistors - SMD 0603 |
| 2 | 4.7k | R-0603 | R17, R6 | Thick Film Resistors - SMD 0603 |
| 2 | 5.1k | R-0603 | R18, R1 | Thick Film Resistors - SMD 0603 |
| 9 | 10k | R-0603 | R16, R3 | Thick Film Resistors - SMD 0603 |
| ^ | 001 | 0.0000 | 200 05 | TI . I FI D |





PCB Assembly **MECHANICAL DESIGN**





































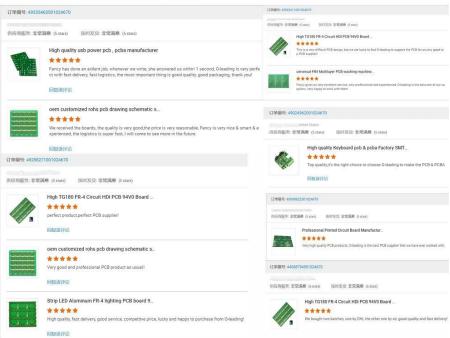


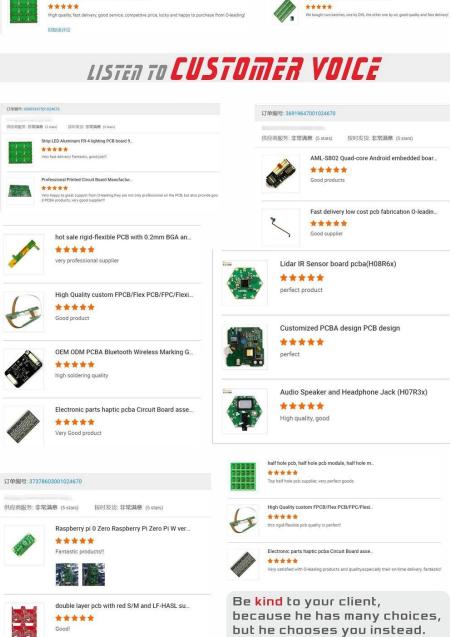




D-LEADING CUSTOMER REVIEW

CUSTOMER VOICE IS EXTREMELY IMPORTANT TO US





Certifications

O-LEADING *TRANING*



Кеер *L Е Д Я Л Л Б*

There's a phrase in Buddhism, 'Beginner's mind.'

lt's wonderful to have a beginner's mind

WE HAVE A DREAM

Кеер *аппппБ*

I would like to live to study and not study to live.

----Bacon









Test Report

No. SZXEC1900530401

Date: 30 Mar 2019

O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

1313.FLOOR 13. FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG,

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. : Date of Sample Received: 22 Mar 2019

RP19-005089 - SZ

22 Mar 2019 - 30 Mar 2019

Testing Period : Test Requested :

Selected test(s) as requested by client.

Test Method :

Please refer to next page(s).

Test Results :

Please refer to next page(s).

Conclusion:

Based on the performed tests on submitted sample(s), the results of Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyl set (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylnexyl) phthalate (DEHP), Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP), and Disobutyl phthalate (DBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

lina

Tina Fan Approved Signatory



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SGS

No. SZXEC1900530401

Date: 30 Mar 2019

Page 2 of 6

Test Report Test Results :

Test Part Description:

SN1

SGS Sample ID SGS Sample ID Description SZX19-005304.001 Green"PCB"

(1) 1 mg/kg = 1 ppm = 0.0001% (2) MDL = Method Detection Limit

(3) ND = Not Detected (< MDL)

(4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC62321-5:2013, IEC62321-7-2:2017, IEC 62321-6:2015 and IEC62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Test Item(s) Limit Unit Cadmium (Cd) 100 ND mg/kg Lead (Pb) 1,000 Mercury (Hg) Hexavalent Chromium (Cr(VI)) 1.000 Sum of PBBs ND 1.000 mg/kg Monobromobiphenyl ND ND ND Dibromobiphenyl Tribromobiphenyl mg/kg mg/kg mg/kg mg/kg ND ND ND Tetrabromobiphenyl Pentabromobiphenyl Hexabromobiphenyl mg/kg mg/kg mg/kg Heptabromobiphenyl ND ND ND ND Octabromobiphenyl Nonabromobiphenyl Decabromobiphenyl mg/kg mg/kg mg/kg ND ND ND Sum of PBDEs 1,000 Monobromodiphenyl ethe Dibromodiphen yl ether mg/kg Tribromodiphenyl ether mg/kg ND Tetrabromodiphenyl ether Pentabromodiphenyl ether



Max

Max

UL Product iQ™



ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

Cond Width

O-LEADING SUPPLY CHAIN (HK) CO LTD

E490354

ROOM 1205, 12/F TAI SANG BANK BLDG 130-132 DES VOEUS ROAD CENTRAL, HONG KONG

| | | Min | Cond | SS/ | Area | Solo | der | Oper | | Meets | c |
|-------------------|---|---------------|----------------------|-----|------------|------|-----|------|-------|----------|--------|
| | Min | Edge | Thk | DS/ | Diam | Lim | its | Temp | Flame | UL796 | T |
| Type | mm(in) | mm(in) | mic(mil) | DSO | mm(in) | c | sec | c | Class | DSR | 1 |
| Multilayer (m | Multilayer (mass laminate) printed wiring boards. | | | | | | | | | | |
| O-LEADING- 401 | 0.1 (0.004) | 0.3 (0.012) | 34 (1.34) | DS | 12.7 (0.5) | 260 | 10 | 130 | V-0 | 100 | :70 |
| O-LEADING- 407 | 0.08 (0.003) | 0.2 (0.008) | 17 (0.67) | DS | 9.7 (0.4) | 260 | 10 | 130 | V-0 | All | - |
| Multilayer pri | Multilayer printed wiring boards. | | | | | | | | | | \neg |
| O-LEADING- 408 | 0.125 (0.005) | 0.125 (0.005) | 12 (0.47) Int:136 | DS | 50.8 (2.0) | 280 | 20 | 130 | V-0 | All | * |
| Single layer p | Single layer printed wiring boards. | | | | | | | | | | |
| O-LEADING- 002 | 0.38 (0.015) | 1.14 (0.045) | 34 (1.34) | SS | 19.1 (0.8) | 260 | 10 | 105 | V-0 | All | - |
| O-LEADING- 003 | 0.38 (0.015) | 1.14 (0.045) | 34 (1.34) | SS | 19.1 (0.8) | 260 | 10 | 130 | V-0 | A | 200 |
| O-LEADING- 033 | 0.15 (0.006) | 0.3 (0.012) | 34 (1.34) | SS | 25.4 (1.0) | 260 | 10 | 120 | V-0 | All | |
| O-LEADING- 205 | 0.1 (0.004) | 0.3 (0.012) | 34 (1.34) | DS | 69.6 (2.7) | 260 | 10 | 130 | V-0 | All | 120 |
| O-LEADING- 206 | 0.15 (0.006) | 0.33 (0.013) | 17 (0.67) | DS | 69.6 (2.7) | 260 | 10 | 130 | V-0 | All | |
| O-LEADING- D01 | 0.14 (0.006) | 0.15 (0.006) | 33 (1.30) | DS | 25.4 (1.0) | 260 | 10 | 130 | V-0 | All | * |
| O-LEADING- S01 | 0.25 (0.010) | 0.25 (0.010) | 17 (0.67) | SS | 25.4 (1.0) | 260 | 4 | 130 | V-0 | All | * |

WIRING, PRINTED - COMPONENT | UL Product iQ

| O-LEADING- S02 | 0.2 (0.008) | 0.2 (0.008) | 17 (0.67) | SS | 25.4 (1.0) | 260 | 4 | 130 | НВ | A | * |
|-------------------|--------------|--------------|-----------|----|------------|-----|---|-----|-----|----------|---|
| O-LEADING- S03 | 0.25 (0.010) | 0.25 (0.010) | 34 (1.34) | SS | 25.4 (1.0) | 260 | 4 | 130 | V-0 | All | * |

 $[\]mbox{\ensuremath{\star}}$ - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

并不是所有出现在本数据库中的公司名称和产品都满足了UL 跟踪检验服务的要求。只有带有 UL 标志的产品,才应该被视为经过UL认证,并满足UL 跟踪检验服务的要求。注意查看产品上的标志。

UL 允许在线认证目录中所含材料的复制遵循以下条件: 1.指南信息、装配、构造、设计、系统和/或认证(文件)必须在不篡攻任何数据(或图纸)的情况下完整且无误导性地呈现。2."经 UL 允许从在线认证目录转载"声明必须出现在所摘取材料的邻近位置。此外,转载材料必须包含以下格式的版权声明:"© 2019 UL LLC"

| Process Capability | | | | | | | |
|--------------------------------------|-----------------------------|---|--|--|--|--|--|
| PCB Production Capabilities | | | | | | | |
| Layer Count | 1Layer-32Layer | | | | | | |
| Finished copper thickness | 1/3oz-12oz | | | | | | |
| Min Line width/spacing internal | 3.0mil/3.0mil | | | | | | |
| Min Line width/spacing external | 4.0mil/4.0mil | | | | | | |
| Max Aspect Ratio | 10:1 | | | | | | |
| Board thickness | 0.2mm-5.0mm | | | | | | |
| Max Panel size(inches) | 635*1500mm | | | | | | |
| Minimum Drilled Hole Size | 4mil | | | | | | |
| Plated Hole Tolerance | +/-3mil | | | | | | |
| Blind/Buried Vias (All Types) | YES | | | | | | |
| Via Fill(Conductive, Non-Conductive) | YES | | | | | | |
| Base Material | FR-4,FR-4high Tg.Halogen fi | ree material,Rogers,Aluminium base,Polyimide,Heavy Copper | | | | | |
| Surface finishes | HASL,OSP,ENIG,HAL-LF,lm | mersion silver,lmmersion Tin,Gold fingers,Carbon ink | | | | | |
| SMT Production Capabilities | | | | | | | |
| PCB Material | | FR-4,CEM-1,CEM-3,Aluminum-based board,FPC | | | | | |
| Max PCB size | | 510x1500mm | | | | | |
| Min PCB size | | 50x50mm | | | | | |
| PCB Thickness | | 0.5mm-4.5mm | | | | | |
| Board thickness | | 0.5-4mm | | | | | |
| Min Components size | | 0201 | | | | | |
| Standard chip size comp | onent | 0603 and larger | | | | | |
| Component max height | | 15mm | | | | | |
| Min lead pitch | | 0.3mm | | | | | |
| Min BGA ball pitch | | 0.4mm | | | | | |
| Placement precision | | +/-0.03mm | | | | | |

Packaging & Delivery

Shipping service











| Quick Turn Lead Time | | | | | | | |
|----------------------|----------|---------------------|--|--|--|--|--|
| Layer Count: | Lead Tim | Special Requirement | | | | | |
| 1L/2L | 2-3days | 24 Hours,48 Hours | | | | | |
| 4L | 3-4days | 48 Hours | | | | | |
| 6L | 4-5days | 72 Hours | | | | | |
| 8L | 5-6days | NA | | | | | |
| 10L | 6-7days | NA | | | | | |
| 12L | 7-8days | NA | | | | | |
| 14L | 8-9days | NA | | | | | |

| | Standard Lead Time | | | | | | |
|--------------|--------------------|------------------------|--|--|--|--|--|
| Layer Count: | Sample Lead Time | Volume order lead time | | | | | |
| 2L | 4 days | 10 days | | | | | |
| 4L | 5 days | 11 days | | | | | |
| 6L | 6 days | 12 days | | | | | |
| 8L | 8 days | 14 days | | | | | |
| 10L | 10 days | 16 days | | | | | |
| 12L | 12 days | 18 days | | | | | |
| 14L | 14 days | 20 days | | | | | |
| 16-32L | 18 days | 24 days | | | | | |

FAQ

1. How do O-Leading ensure quality?

Our high quality standard is achieved with the following.

- 1.1 The process is strictly controlled under ISO 9001:2008 standards.
- 1.2 Extensive use of software in managing the production process
- 1.3 State-of-art testing equipments and tools. E.g. Flying Probe, X-ray Inspection, AOI (Automated Optical Inspector) and ICT (in-circuit testing).
- 1.4. Dedicated quality assurance team with failure case analysis process
- 1.5. Continuous staff training and education

2. How do O-Leading keep your price competitive?

Over the last decade, prices of many raw materials (e.g. copper, chemicals) had doubled, tripled or quadrupled; Chinese currency RMB had appreciated 31% over US dollar; And our labor cost also increased significantly.

However, O-Leading have kept our pricing steady. This owns entirely to our innovations in reducing cost, avoiding wastes and improving efficiency. Our prices are very competitive in the industry at the same quality level.

We believe in a win-win partnership with our customers. Our partnership will be mutually beneficial if we can provide you an edgeon cost and quality.(Fast Delivery Double Side Pcb Board

Manufacturer)

3. What kinds of boards can O-Leading process?

Common FR4, high-TG and halogen-free boards, Rogers, Arlon, Telfon, aluminum/copper-based boards, PI, etc.

4. What data are needed for PCB & PCBA production?

- 4.1 BOM (Bill of Materials) with reference designators: component description, manufacturer's name and part number.
- 4.2 PCB Gerber files.
- 4.3 PCB fabrication drawing and PCBA assembly drawing.
- 4.4 Test procedures.
- 4.5 Any mechanical restrictions such as assembly height requirements.

5. What's the typical process flow for multi-layer PCB?

Material cutting → Inner dry film → inner etching → Inner AOI → Multi-bond → Layer stack up Pressing → Drilling → PTH → Panel Plating → Outer Dry Film → Pattern Plating → Outer etching → Outer AOI → Solder Mask → Component Mark → Surface finish → Routing → E/T → Visual Inspection.

6. What's the key equipments for HDI manufacturing?

Key equipment list is as following: Laser drilling machine, Pressing machine, VCP line, Automatic Exposing machine, LDI and etc.

The equipments we have are the best in the industry, laser drilling machines are from Mitsubishi and Hitachi, LDI machines are from Screen(Japan), Automatic Exposing machines are also from Hitachi, all of them make we can meet customer's technical requirements.

7. How many types of surface finish O-lead can do?

O-the leader has the full series of surface finish, such as: ENIG, OSP, LF-HASL, gold plating (soft/hard), immersion silver, Tin, silver plating, immersion tin plating, carbon ink and etc. .. OSP, ENIG, OSP + ENIG commonly used on the HDI, we usually recommend that you use a client or OSP OSP + ENIG if BGA PAD size less than 0.3 mm.

8. What's your capability for FPC? Can O-Leading provide SMT service also?

O-Leading can fabricate FPC from single layer to 8layer, the working panel size can be as large as 2000mm*240mm, please find the details in the page "Flex Capability" We also provide SMT one stop service to customer.

9. What are the main factors which will affect the price of PCB?

Material;

Surface finish;

Technology difficulty;

Different quality criteria;

PCB characteristics;

Payment terms;

Different manufacturing countries.

10. What's the definition of PCB, PWB and FPC and what's the difference?

PCB is short for Printed Circuit Board;

PWB is short for Printed Wire Board, same meaning as Printed Circuit Board; FPC is short for Flexible Printed Board.

11. What factors should be considered when choosing the material for a PCB board?

Below factors should be considered when we choose the material for PCB:

The material's Tg value should be greater than the operation temperature;

Low CTE material has good performance of thermal stability;

Good thermal resistance performance: Normally PCBs are required to resist 250°C for at least 50s. Good flatness; In consideration of the electrical properties, low loss/high permittivity material is used on high frequency PCB; Polyimide glass fiber substrate used for flexible PCB; Metal core is used when the product has strict requirement of heat dissipation.

12. What's the merits of O-leading's rIgid-flex PCB?

O-leading's rigid-flex PCB has the characters of both FPC and PCB, so it can be used in some special products. Some part is flexible while the other part rigid, it can help save product's interior space, reduce product volume and improve performance.

13. How to you make the impedance calculation?

The impedance control system is done using some test coupons, the SI6000 soft and the CITS 500s equipment from POLAR INSTRUMENTS.

The equipment measures the impedance on a representative track configuration coupon of which the client has given us a determinate value and tolerance.